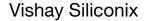
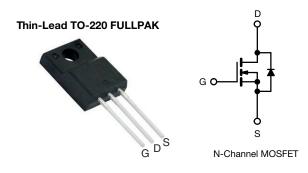
## SiHA22N60AE





# **E Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.156		
Q <sub>g</sub> max. (nC)	96			
Q <sub>gs</sub> (nC)	12			
Q <sub>gd</sub> (nC)	25			
Configuration	Single			



### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-Free	SiHA22N60AE-E3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	600	v		
Gate-Source Voltage			V <sub>GS</sub>	± 30	v		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	20			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		12	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	49			
Linear Derating Factor				1.4	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	204	mJ		
Maximum Power Dissipation			PD	33	W		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		-1) / / -1+	70	V/ns		
Reverse Diode dV/dt <sup>d</sup>			dV/dt	31	V/ns		
Soldering Recommendations (Peak temperature) <sup>c</sup>	For 10 s			300	°C		
Mounting Torque	M3 screw			0.6	Nm		

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,~I_{AS}$  = 3.8 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

e. Limited by maximum junction temperature.

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		65				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 3.8				- °C/W		
SPECIFICATIONS (T <sub>J</sub> = 25 $^{\circ}$ C, u	unless otherw	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static						•		•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 25	50 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>C</sub>	<sub>0</sub> = 250 μA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 μA	2	-	4	V
Cata Source Leekage	1		$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>				-	-	± 1	μA
Zaro Cata Valtago Drain Current	1-	V <sub>DS</sub> =	= 600 V, V <sub>GS</sub>	s = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 480 \	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$		-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 11 A	-	0.156	0.180	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	11 A	-	4.8	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1451	-	pF	
Output Capacitance	C <sub>oss</sub>			-	73	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	5	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	50	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	258	-		
Total Gate Charge	Qg				-	48	96	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V		-	12	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	25	-	1
Turn-On Delay Time	t <sub>d(on)</sub>		•		-	19	38	
Rise Time	t <sub>r</sub>	V <sub>PP</sub> -	- 480 V In -	- 11 Δ	-	33	66	1
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{DD}$ = 480 V, I <sub>D</sub> = 11 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 9.1 Ω		-	45	90	ns
Fall Time	t <sub>f</sub>			-	21	42	1	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.3	0.6	1.2	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20	- A	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	49		
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ dl/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		-	319	638	ns	
Reverse Recovery Charge	Q <sub>rr</sub>			-	4.9	9.8	μC	
Reverse Recovery Current	I <sub>RRM</sub>			_	28	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

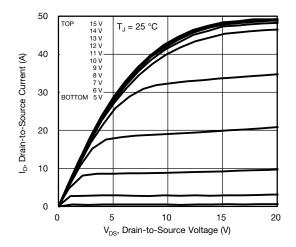


Fig. 1 - Typical Output Characteristics

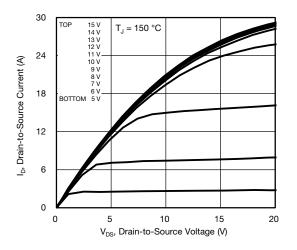


Fig. 2 - Typical Output Characteristics

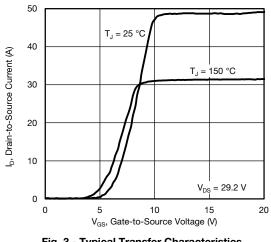


Fig. 3 - Typical Transfer Characteristics

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3.0 = 11 A R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.5 1.0 10 \ GS 0.5 0 -20 -60 -40 20 40 60 80 100 120 140 160 0 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

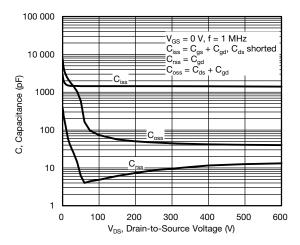


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

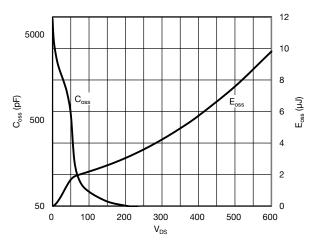


Fig. 6 - Coss and Eoss vs. VDS

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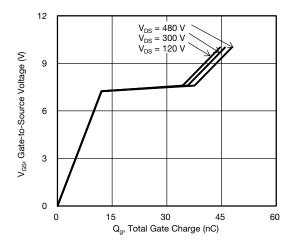


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

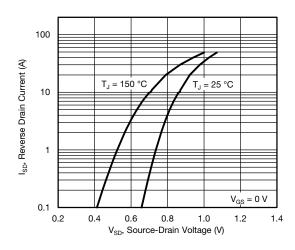


Fig. 8 - Typical Source-Drain Diode Forward Voltage

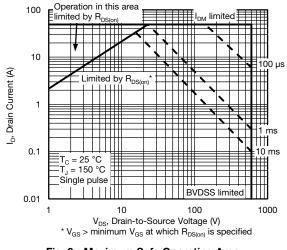


Fig. 9 - Maximum Safe Operating Area

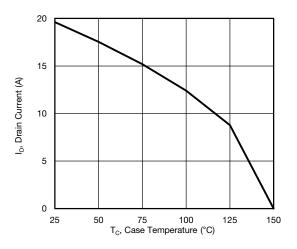


Fig. 10 - Maximum Drain Current vs. Case Temperature

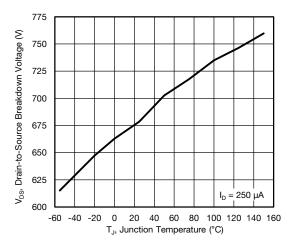
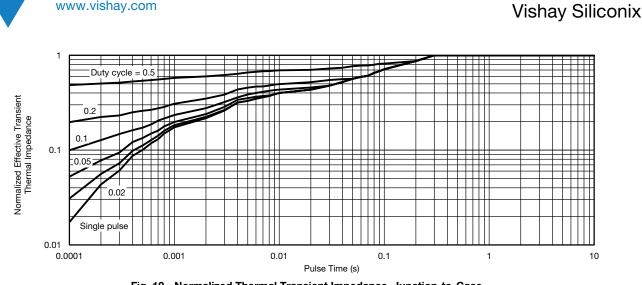
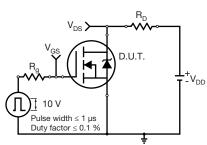


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

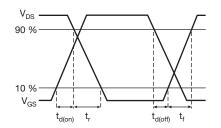


Fig. 14 - Switching Time Waveforms

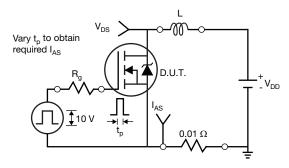


Fig. 15 - Unclamped Inductive Test Circuit

DS VDD  $V_{\rm DS}$ IAS

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Fig. 16 - Unclamped Inductive Waveforms

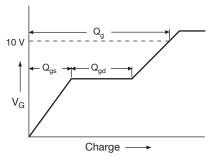


Fig. 17 - Basic Gate Charge Waveform

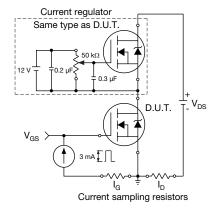
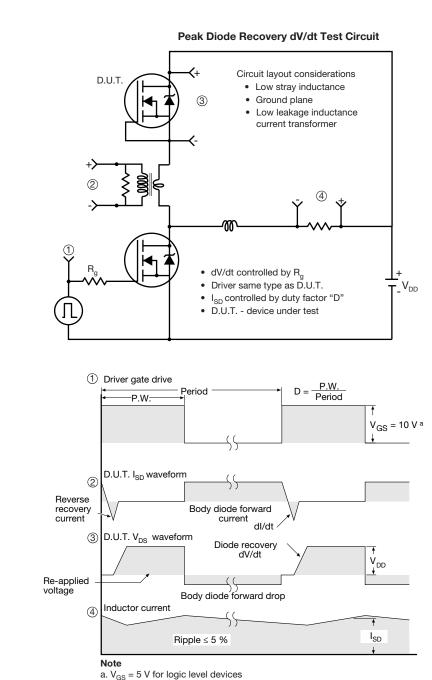


Fig. 18 - Gate Charge Test Circuit

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v for logic level devices

Fig. 19 - For N-Channel

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